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FDMS86150ET100

N-Channel Shielded Gate PowerTrench[®] MOSFET 100 V, 128 A, 4.85 m Ω

Features

- Extended T_J rating to 175°C
- Shielded Gate MOSFET Technology
- Max $r_{DS(on)}$ = 4.85 m Ω at V_{GS} = 10 V, I_D = 16 A
- Max $r_{DS(on)}$ = 7.8 m Ω at V_{GS} = 6 V, I_D = 13 A
- Advanced Package and Silicon combination for low r_{DS(on)} and high efficiency
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

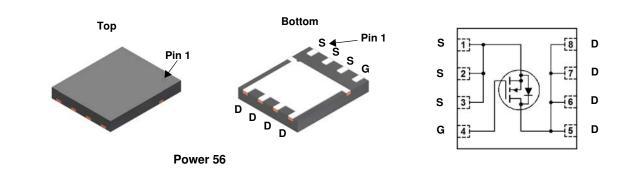


General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

Applications

- Primary DC-DC MOSFET
- Secondary Synchronous Rectifier
- Load Switch



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C	(Note 5)	128	A	
	-Continuous	T _C = 100 °C	(Note 5)	90		
ID	-Continuous	T _A = 25 °C	(Note 1a)	16		
	-Pulsed		(Note 4)	617		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	726	mJ	
P _D	Power Dissipation	T _C = 25 °C		187	w	
	Power Dissipation	T _A = 25 °C	(Note 1a)	3.3		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +175	°C	

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	0.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (Note 1a) 45	0/10

Package Marking and Ordering Information

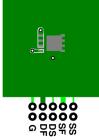
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86150ET	FDMS86150ET100	Power 56	13 "	12 mm	3000 units

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⁻ DMS86150ET100 N-Channel Shielded Gate PowerTrench [®] MOSFET

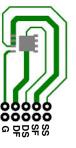
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Chara	acteristics						
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$	100			V	
ΔΒV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		72		mV/°C	
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μA	
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
On Chara	acteristics						
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2	3	4	V	
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-10		mV/°C	
	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 16 A		3.9	4.85		
r _{DS(on)}		V _{GS} = 6 V, I _D = 13 A		6	7.8	mΩ	
		V_{GS} = 10 V, I_{D} = 16 A, T_{J} = 125 °C		7.3	9.1		
9 _{FS}	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 16 \text{ A}$		53		S	
Dynamic	Characteristics						
C _{iss}	Input Capacitance	N 50 X X 0 X		3055	4065	pF	
C _{oss}	Output Capacitance	── V _{DS} = 50 V, V _{GS} = 0 V, — f = 1 MHz		696	930	pF	
C _{rss}	Reverse Transfer Capacitance			29	50	pF	
R _g	Gate Resistance		0.1	0.7	3.6	Ω	
Switching	g Characteristics						
t _{d(on)}	Turn-On Delay Time			18	33	ns	
t _r	Rise Time	V _{DD} = 50 V, I _D = 16 A,		8.3	17	ns	
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		28	45	ns	
f	Fall Time	-		6	12	ns	
Q _g	Total Gate Charge	V _{GS} = 0 V to 10 V		44	62	nC	
Q _g	Total Gate Charge	$V_{GS} = 0 V \text{ to } 5 V V_{DD} = 50 V,$		25	35	nC	
Q _{gs}	Gate to Source Charge	I _D = 16 A		12.9		nC	
Q _{gd}	Gate to Drain "Miller" Charge			9.2		nC	
Drain-So	urce Diode Characteristics						
		V _{GS} = 0 V, I _S = 2.1 A (Note 2)		0.69	1.2		
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 16 A$ (Note 2)		0.78	1.3	V	
	Deveree Desever Time			69	110	ns	
t _{rr}	Reverse Recovery Time	— I _F = 16 A, di/dt = 100 A/μs		03	110	115	

Notes:

1. $R_{\theta JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta CA}$ is determined by the user's board design.



a. 45 °C/W when mounted on a 1 in² pad of 2 oz copper.



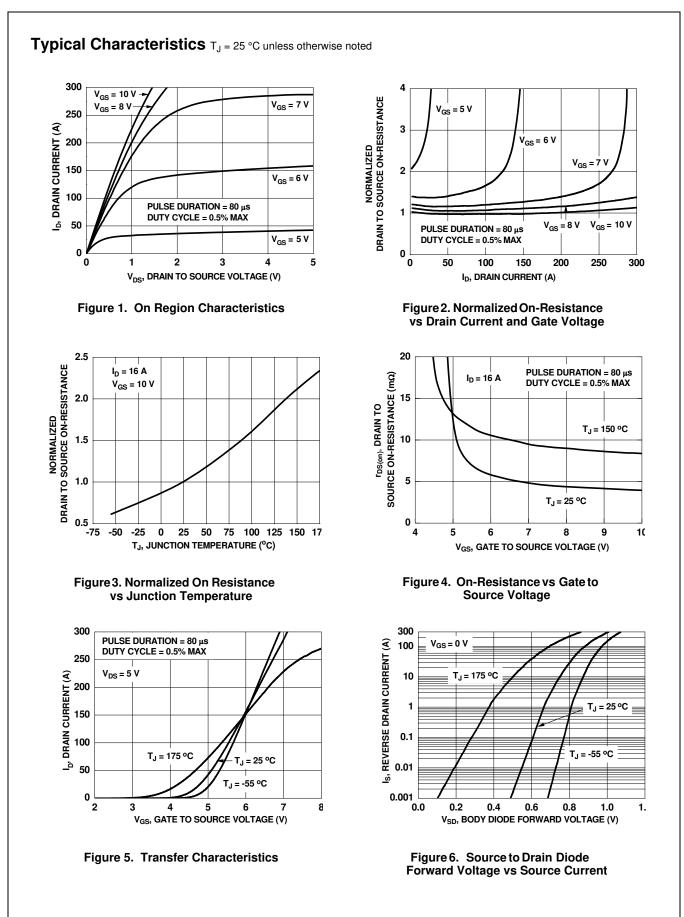
b. 115 °C/W when mounted on a minimum pad of 2 oz copper.

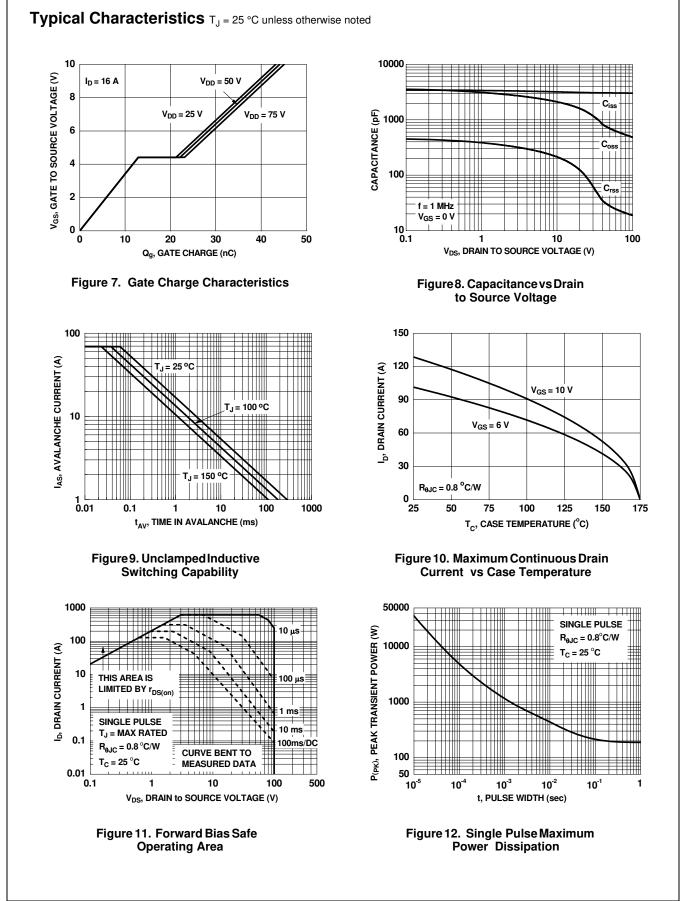
3. E_{AS} of 726 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 22 A, V_{DD} = 100 V, V_{GS} = 10 V, 100% test at L = 0.1 mH, I_{AS} = 69 A.

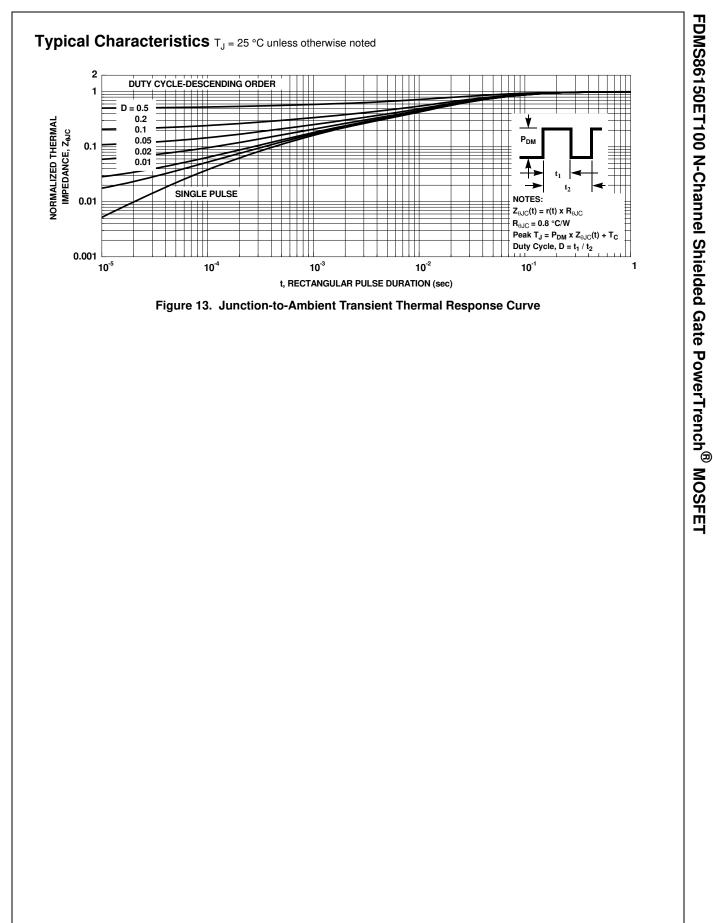
4. Pulse Id please refer to Fig.11 SOA curve for detail.

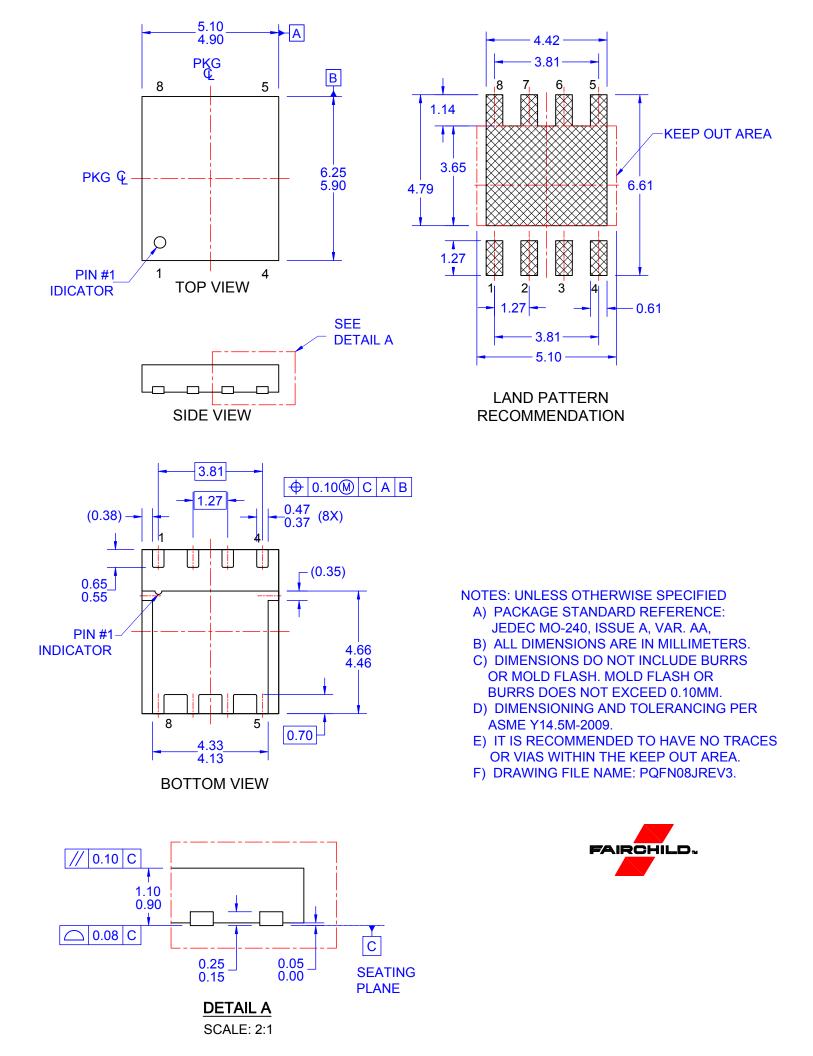
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

FDMS86150ET100 N-Channel Shielded Gate PowerTrench[®] MOSFET









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